

L Number	Hits	Search Text	DB	Time stamp
1	16	((slop\$3 or inclin\$3 or taper\$3) with (etch\$3)) and 430/320.cccls.) not (((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) with (etch\$3)) and ((grey or gray) same (mask or reticle))) not (((((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) same (etch\$3)) and ((grey or gray) same (photomask or mask or reticle))) not (((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) with (etch\$3)) and ((grey or gray) same (photomask or mask or reticle))) not (((((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) same (etch\$3)) and ((grey or gray) same (photomask or mask or reticle))) not (((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) with (etch\$3)) and ((grey or gray) same (photomask or mask or reticle))) not (((((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) with (etch\$3)) and ((grey or gray) same (photomask or mask or reticle))) not (((mems or moems or microelectromechanical or micro adj electromechanical).ti.ab.) and (microbeam or microplatform or microsupport or (suspend\$3 with microstructure))) not (((photolithograph\$6 or lithograph\$6 or photoresist or resist) and etch\$3 and (204/192.14-192.15,192.17,192.23,192.25 or 205/122-123,125).cccls.) not 430/314,323-324.cccls.) not (((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) with (etch\$3)) and ((grey or gray) same (mask or reticle))) not (resistive adj evaporat\$3 and ((photolithograph\$6 or photoresist or resist) same etch\$3)) not (430/314,323-324.cccls. and (planarization adj layer) not (((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) with (etch\$3)) and ((grey or gray) same (photomask or mask or reticle))) not (((((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) same (etch\$3)) and ((grey or gray) same (photomask or mask or reticle))) not (((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) with (etch\$3)) and ((grey or gray) same (photomask or mask or reticle)))) not ((resist or photoresist) and (air adj bridge same (slop\$3 or inclin\$3 or taper\$3))) not ((resist or photoresist) and ((microbeam) same (slop\$3 or inclin\$3 or taper\$3)))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/01/24 16:40
-	830	((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) and (etch\$3)) and (grey or gray)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/01/24 16:24
-	35	((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) with (etch\$3)) and ((grey or gray) same (mask or reticle))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/01/18 13:41
-	0	((((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) with (etch\$3)) and ((grey or gray) same (mask or reticle))) not us.pc.	DERWENT	2003/01/16 17:37

-	0	(430/314,323-324.cccls. not (((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) with (etch\$3)) and ((grey or gray) same (mask or reticle))) not us.pc.	DERWENT	2003/01/16 17:37
-	2920	430/314,323-324.cccls. not (((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) with (etch\$3)) and ((grey or gray) same (mask or reticle))) ("5962909") or ("5831266") or ("6130109") or ("6025951") or ("6201243") or ("20020043706").PN.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/01/17 17:08
-	6	((("5962909") or ("5831266") or ("6130109") or ("6025951") or ("6201243") or ("20020043706")).PN. (((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) with (etch\$3)) and ((grey or gray) same (photomask or mask or reticle)))	USPAT; US-PGPUB	2003/01/17 09:20
-	35	(((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) with (etch\$3)) and ((grey or gray) same (photomask or mask or reticle)))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/01/17 15:37
-	29	(((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) with (etch\$3)) and ((grey or gray) with (photomask or mask or reticle)))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/01/17 15:37
-	58	(((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) same (etch\$3)) and ((grey or gray) same (photomask or mask or reticle)))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/01/17 15:41
-	23	(((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) same (etch\$3)) and ((grey or gray) same (photomask or mask or reticle))) not (((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) with (etch\$3)) and ((grey or gray) same (photomask or mask or reticle)))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/01/17 15:41
-	2919	430/314,323-324.cccls. not (((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) with (etch\$3)) and ((grey or gray) same (photomask or mask or reticle))) not (((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) same (etch\$3)) and ((grey or gray) same (photomask or mask or reticle))) not (((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) with (etch\$3)) and ((grey or gray) same (photomask or mask or reticle)))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/01/23 11:28
-	623	(mems or moems or microelectromechanical or micro adj electromechanical).ti.ab.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/01/18 11:46
-	26	((mems or moems or microelectromechanical or micro adj electromechanical).ti.ab.) and (microbeam or microplatform or microsupport or (suspend\$3 with microstructure))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/01/18 11:47
-	884	(photolithograph\$6 or lithograph\$6 or photoresist or resist) and etch\$3 and (204/192.14-192.15,192.17,192.23,192.25 or 205/122-123,125).cccls.	USPAT; US-PGPUB	2003/01/18 13:38
-	827	((photolithograph\$6 or lithograph\$6 or photoresist or resist) and etch\$3 and (204/192.14-192.15,192.17,192.23,192.25 or 205/122-123,125).cccls.) not 430/314,323-324.cccls.	USPAT; US-PGPUB	2003/01/18 13:39
-	827	((photolithograph\$6 or lithograph\$6 or photoresist or resist) and etch\$3 and (204/192.14-192.15,192.17,192.23,192.25 or 205/122-123,125).cccls.) not 430/314,323-324.cccls.) not (((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) with (etch\$3)) and ((grey or gray) same (mask or reticle)))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/01/18 13:44
-	17	resistive adj evaporat\$3 and ((photolithograph\$6 or photoresist or resist) same etch\$3)	USPAT; US-PGPUB	2003/01/20 15:35

-	6636	electroplat\$3 and ((photolithograph\$6 or photoresist or resist) same etch\$3) 430/314,323-324.ccls. and (planarization adj layer) not (((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) with (etch\$3)) and ((grey or gray) same (photomask or mask or reticle))) not (((((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) same (etch\$3)) and ((grey or gray) same (photomask or mask or reticle))) not (((resist or photoresist) and (slop\$3 or inclin\$3 or taper\$3)) with (etch\$3)) and ((grey or gray) same (photomask or mask or reticle))))	USPAT; US-PGPUB; USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/01/20 15:35
-	34			2003/01/23 11:31
-	440	(resist or photoresist) and (air adj bridge)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/01/23 17:03
-	210	(resist or photoresist) same (air adj bridge)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/01/23 17:04
-	10	(resist or photoresist) and (air adj bridge same (slop\$3 or inclin\$3 or taper\$3))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/01/23 19:05
-	1	((resist or photoresist) and ((microplatform or suspend\$3) same (slop\$3 or inclin\$3 or taper\$3))) and ((grey or gray) with mask)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/01/23 19:08
-	2	(resist or photoresist) and ((microbeam) same (slop\$3 or inclin\$3 or taper\$3))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/01/23 19:10
-	900	(resist or photoresist) and ((microplatform or suspend\$3) same (slop\$3 or inclin\$3 or taper\$3))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/01/24 11:20